

**1A CONSTANT CURRENT BUCK  
 REGULATOR FOR HIGH POWER LEDs**
**DESCRIPTION**

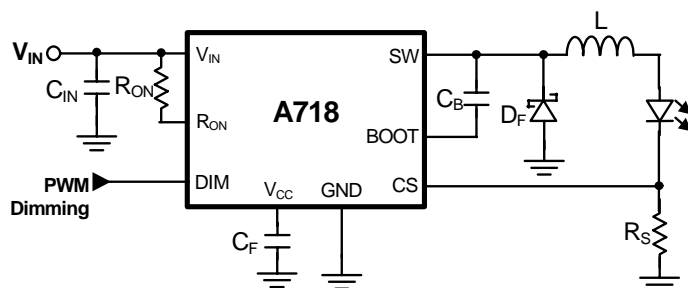
The A718 is a monolithic switching regulator designed to drive high power LEDs with constant current and is suitable for automotive, industrial, and general lighting applications. The step-down (Buck) regulator contains a high-side N-channel MOSFET switch with a current limit of 1.5A. Hysteretic controlled on-time and an external resistor allow the converter output voltage to adjust as needed to deliver a constant current to series and series-parallel connected LED arrays of varying number and type.

A718 provides broken/open LED protection, low-power shutdown protection and thermal shutdown protection. LED dimming control can be accomplished by pulse width modulation (PWM) via DIM pin.

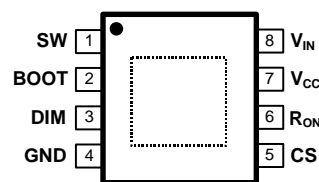
**FEATURES**

- **Wide Input Range: 6V to 35V.**
- **Integrated Power Switch: 1.5A Guaranteed.**
- **Cycle-by-Cycle Current Limit.**
- **No Control Loop Compensation Required.**
- **Separate PWM Dimming.**
- **Supports all-ceramic output capacitors and capacitor-less outputs.**
- **Thermal Shutdown Protection**
- **Available in Package of SOP 8-Pin with Thermal Pad.**

13428943627

**TYPICAL APPLICATION CIRCUIT****APPLICATIONS**

- LED Driver
- Constant Current Source
- Automotive Lighting
- General Lighting
- Industrial Lighting

**PACKAGE PIN OUT**
**SOP-EP 8 Pin  
 (Top View)**
**ORDER INFORMATION**

<b>E</b>	SOP-EP
	8 pin
A718EFT	
Note: All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number (i.e. A718EFT). The letter "F" is marked for Lead Free process.	

Preliminary

**ABSOLUTE MAXIMUM RATINGS** (Note)

$V_{IN}$ to GND	-0.3V to 40V
BOOT to GND	-0.3V to 40V
SW to GND	-1.5V to 40V
BOOT to $V_{CC}$	-0.3V to 40V
BOOT, $V_{CC}$ to SW	-0.3V to 14V
DIM, CS, $R_{ON}$ to GND	-0.3V to 7V
Maximum Operating Junction Temperature, $T_J$	150°C
Storage Temperature Range	-65°C to 125°C
Lead Temperature (Soldering, 10 seconds)	260°C
Note: Exceeding these ratings could cause damage to the device. Currents are positive into, negative out of the specified terminal.	

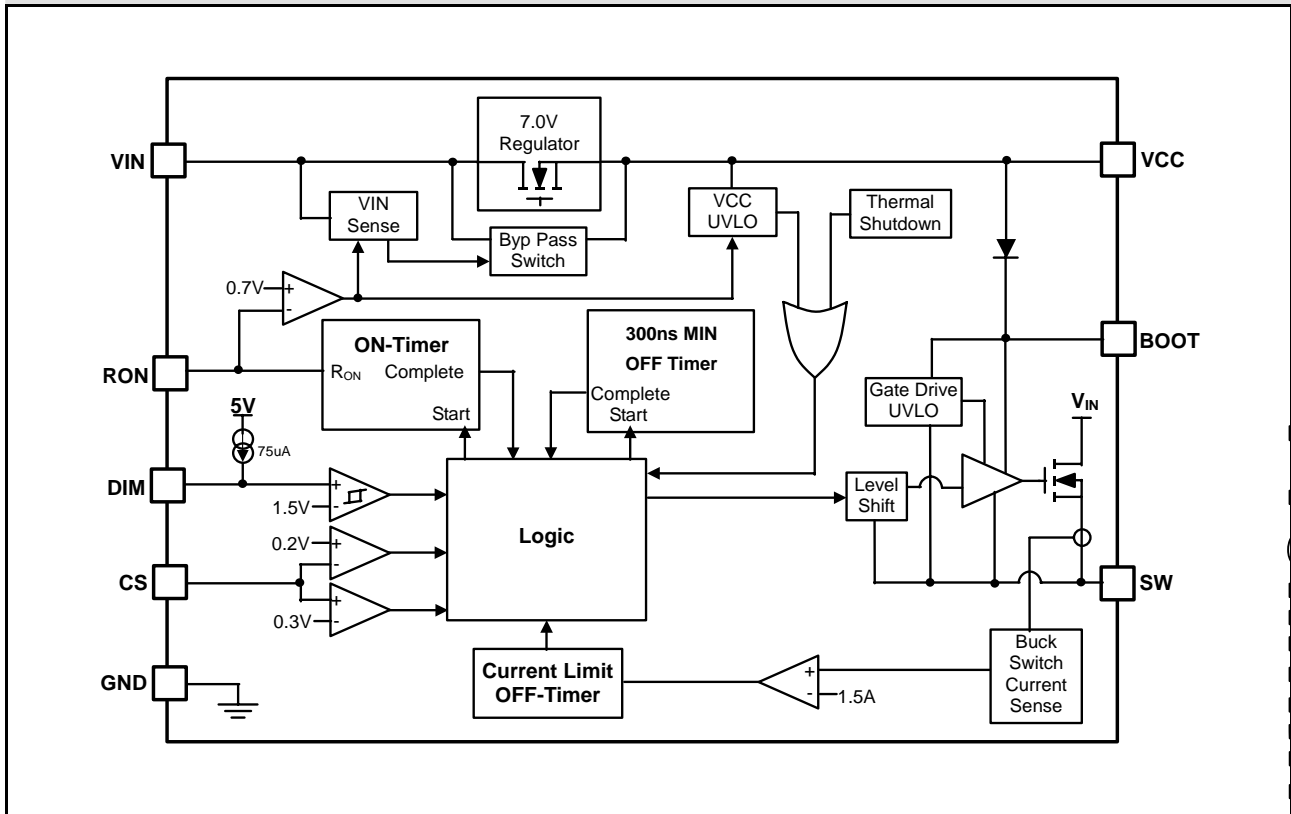
**RECOMMENDED OPERATING RATINGS**

$V_{IN}$	6V to 35V
Junction Temperature Range	-40°C to 125°C

**PIN DESCRIPTION**

Pin	Name	Pin Function
1	SW	Connect this pin to the output inductor and Schottky diode.
2	BOOT	Connect a 10nF ceramic capacitor from this pin to SW pin.
3	DIM	Connect a logic-level PWM signal to this pin to enable/disable the power MOSFET and reduce the average light output of the LED array.
4	GND	Connect this pin to system ground.
5	CS	Set the current through the LED array by connecting a resistor from this pin to ground.
6	$R_{ON}$	A resistor connected from this pin to $V_{IN}$ sets the regulator controlled on-time.
7	$V_{CC}$	Bypass this pin to ground with a minimum 0.1 $\mu$ F ceramic capacitor with X5R or X7R dielectric.
8	$V_{IN}$	Input supply pin.
Thermal Pad	GND	Connect to ground. Place 4-6 vias from top to bottom layer ground plane.

Preliminary

**BLOCK DIAGRAM**

**THERMAL DATA**

Thermal Resistance from Junction to Ambient, $\theta_{JA}$	165°C /W
<p>Junction Temperature Calculation: <math>T_J = T_A + (P_D \times \theta_{JA})</math>.</p> <p>The <math>\theta_{JA}</math> numbers are guidelines for the thermal performance of the device/pc-board system. Connect the ground pin to ground using a large pad or ground plane for better heat dissipation. All of the above assume no ambient airflow.</p>	

**Maximum Power Calculation:**

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_{A(MAX)}}{\theta_{JA}}$$

$T_J$  (°C): Maximum recommended junction temperature

$T_A$  (°C): Ambient temperature of the application

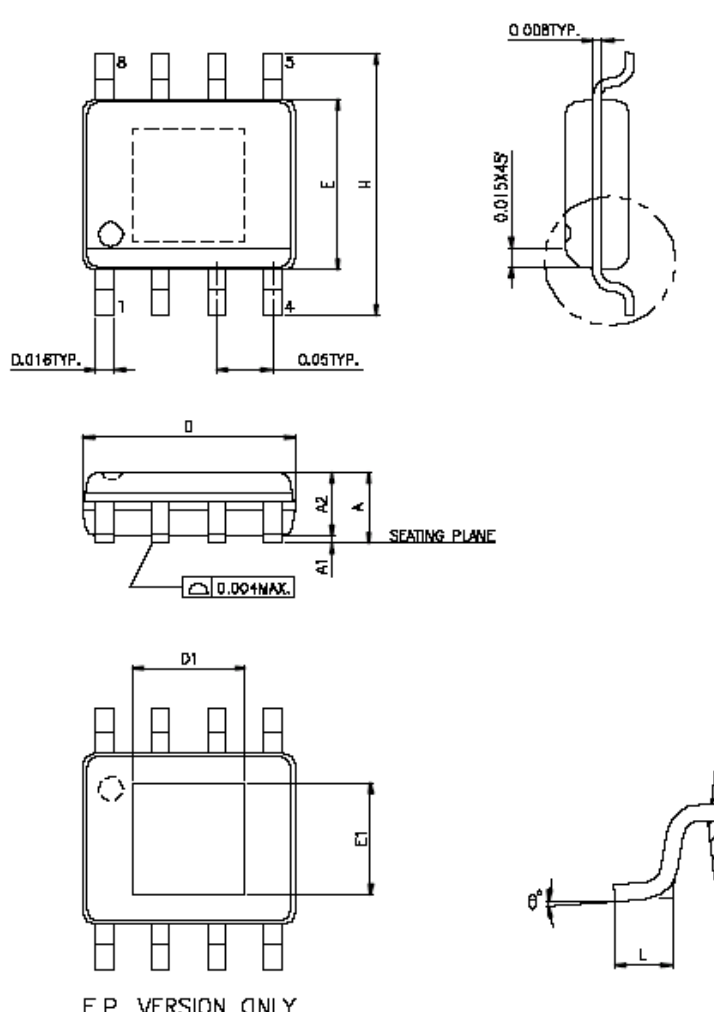
$\theta_{JA}$  (°C /W): Junction-to-Ambient thermal resistance of the package, and other heat dissipating materials.

Preliminary

**DC ELECTRICAL CHARACTERISTICS**

$V_{IN} = 24V, T_A = 25^{\circ}C$ , (Unless otherwise noted)						
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
On-time 1	$t_{ON-1}$	$V_{IN}=10V, R_{ON}=200k\Omega$	2.1	2.75	3.4	us
On-time 2	$t_{ON-2}$	$V_{IN}=40V, R_{ON}=200k\Omega$	515	675	835	ns
CS Regulation Threshold	$V_{REF-REG}$	CS Decreasing, SW turns on	194	200	206	mV
CS Over-Voltage Threshold	$V_{REF-0V}$	CS Increasing, SW turns off		300		mV
CS Bias Current	$I_{CS}$	CS=0V		0.1		uA
Shutdown Threshold	$V_{STD-TH}$	$R_{ON} / SD$ Increasing	0.3	0.7	1.05	V
Shutdown Hysteresis	$V_{STD-HYS}$	$R_{ON} / SD$ Decreasing		40		mV
Minimum Off-time	$t_{OFF-MIN}$	CS=0V		400		ns
$V_{CC}$ Regulated Output	$V_{CC-REG}$		6.0	7	7.4	V
$V_{IN} - V_{CC}$	$V_{IN-DO}$	$I_{CC}=5mA, 6.0V < V_{IN} < 8.0V$		400		mV
$V_{CC}$ Bypass Threshold	$V_{CC-BP-TH}$	$V_{IN}$ Increasing		8.8		V
$V_{CC}$ Bypass Hysteresis	$V_{CC-BP-HYS}$	$V_{IN}$ Decreasing		230		mV
$V_{CC}$ Current Limit (Note)	$V_{CC-LIM}$	$V_{CC}$ Current Limit (Note 3)		16		mA
$V_{CC}$ UVLO Threshold	$V_{CC-UV-TH}$	$V_{CC}$ Increasing		5.3		V
$V_{CC}$ UVLO Hysteresis	$V_{CC-UV-HYS}$	$V_{CC}$ Decreasing		150		mV
$V_{CC}$ UVLO Filter Delay	$V_{CC-UV-DLY}$	100 mV Overdrive		3		us
$I_{IN}$ Operating Current	$I_{IN-OP}$	Non-switching, CS=0.5V		625	900	uA
Current Limit Threshold	$I_{LIM}$	Current Limit Threshold	1.5			A
DIM Input High Voltage	$V_{IH}$	DIM Increasing	2.2			V
DIM Input Low Voltage	$V_{IL}$	DIM Decreasing			0.8	V
DIM Pull-up Current	$I_{DIM-PU}$	DIM=1.5V		80		uA
Buck Switch On Resistance	$R_{DS-ON}$	$I_{SW}=200mA, BST-SW=6.3V$		0.37	0.75	$\Omega$
BST UVLO Threshold	$V_{DR-UVLO}$	BST-SW Increasing	1.7	3	4	mV
BST UVLO Hysteresis	$V_{DR-HYS}$	BST-SW Decreasing		400		
Thermal Shutdown Threshold	$T_{SD}$			165		$^{\circ}C$
Thermal Shutdown Hysteresis	$T_{SD-HYS}$			25		

Note :  $V_{CC}$  provides self bias for the internal gate drive and control circuits. Device thermal limitations limit external loading.

**PACKAGE**
**8-Pin Plastic S.O.I.C.**


Technical drawing of an 8-Pin Plastic S.O.I.C. package. The drawing includes a top view showing dimensions D, E, H, and lead lengths L. A detail view shows a lead with a diameter of 0.015x45 and a length of 0.008TYP. Another detail view shows a lead with a diameter of 0.018TYP. A side view shows dimensions A, A1, A2, and a seating plane. A note indicates a maximum surface finish of 0.004MAX. The E.P. version only is noted.

SYMBOLS	MIN.	MAX.
A	0.053	0.069
A1	0.002	0.006
A2	-	0.059
D	0.189	0.196
E	0.150	0.157
H	0.228	0.244
L	0.016	0.050
θ°	0	8

UNIT: INCH

THERMALLY ENHANCED DIMENSIONS		
PAD SIZE	E1	D1
90X90E	0.081 REF	0.081 REF
95X13E	0.086 REF	0.117 REF

UNIT: INCH

NOTES:

- JEDEC OUTLINE. N/A
- DIMENSIONS "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 15mm (.005in) PER SIDE.
- DIMENSIONS "E" DOES NOT INCLUDE INTER-LEAD FLASH, OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED .25mm (.010in) PER SIDE.

E.P. VERSION ONLY

Preliminary

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